

Multifractal characteristics of titanium nitride thin films

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The study presents a multi-scale microstructural characterization of three-dimensional (3-D) micro-textured surface of titanium nitride (TiN) thin films prepared by reactive DC magnetron sputtering in correlation with substrate temperature variation. Topographical characterization of the surfaces, obtained by atomic force microscopy (AFM) analysis, was realized by an innovative multifractal method which may be applied for AFM data. The surface micromorphology demonstrates that the multifractal geometry of TiN thin films can be characterized at nanometer scale by the generalized dimensions D_q and the singularity spectrum $f(\alpha)$. Furthermore, to improve the 3-D surface characterization according with ISO 25178-2:2012, the most relevant 3-D surface roughness parameters were calculated. To quantify the 3-D nanostructure surface of TiN thin films a multifractal approach was developed and validated, which can be used for the characterization of topographical changes due to the substrate temperature variation.

Keywords: *atomic force microscopy; DC magnetron sputtering; multifractal analysis; surface roughness; titanium nitride (TiN) thin film*

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1. Introduction

New materials and/or new thin film deposition technologies are broadly used in technological applications in microelectronics, optoelectronics, biomedical engineering and microsystems [1–4].

Titanium nitride (TiN) is an extremely hard ceramic material, often used as a coating on titanium alloys, steel, carbide, and aluminium components to improve the substrate surface properties. TiN has an ideal combination of hardness, toughness, adhesion and inertness. It is used in the microelectronics industry as a diffusion barrier material, and to the hard and protective coatings on mechanical tools and decorative coatings [5, 6]. The advantages of TiN thin film coatings include high

hardness and adhesion, good ductility, excellent lubricity, high chemical stability and tough resistance to wear, corrosion and temperature. The relationships between the TiN processing parameters, the film structure and properties were determined in different types of studies [7, 8]. The mechanical properties of TiN film are correlated with the fine grains, the crystallographic orientation, high compressive residual stresses or the dense defect-free structure of the coatings. Also, the resistivity of TiN thin films is correlated with thickness and the packing factor for all coating angles (the angle between specimen surface and the evaporating source) [5, 9]. TiN coatings are generally prepared by PVD (Physical Vapor Deposition) techniques. Direct-current (DC) magnetron sputtering is one of the dominant methods for thin film fabrication, that can be applied also for the preparation of TiN thin films [2, 10–12].

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Hofmann [13] proposed a systematic study of nitrides formation by sputtering titanium targets in Ar/N₂ mixtures. Mientus and Ellmer [14] investigated the discharge characteristics of a series of elemental targets (aluminium, silicon, titanium, chromium, indium, tin) during reactive magnetron sputtering in Ar/N₂ mixtures. The authors concluded that the deposition rate decreases when nitrogen partial pressure increases [14]. In this study, our particular aspect relates to improving material characterization of 3-D surface roughness of TiN thin films prepared by reactive DC magnetron sputtering, through atomic force microscopy (AFM) and multifractal analysis. The multifractal modeling was originally developed for the study of the 3-D surface roughness to characterize the spatial inhomogeneity of fractal patterns.

2. Materials and methods

2.1. Materials

The TiN thin film was deposited on a p-type silicon (100) substrate by reactive DC magnetron sputtering technique in an Ar + N₂ atmosphere. Ar and nitrogen gases (with high purity: 99.999 %) and with the ratio Ar (97 %) and N₂ (3 %) by volume were used as reactive sputtering gases. This system consisted of planar Ti metal (99.99 % purity) with 5 cm diameter. The average distance between the target and the wafer was 3 cm. A rotary pump (ALCATEL) and defusing pumps were used to evacuate the growth chamber up to a pressure of 1×10^{-3} Pa. Then, the reactive sputtering gases were introduced into the sputter chamber.

During the growth of all samples the pressure in the sputter chamber was constant, with a value of 2.66 Pa, at a current density of 10 mA/cm². The films were deposited in three states at four different substrate temperatures: 473 K, 573 K, 673 K, and 773 K, respectively, at the same deposition time of 120 min.

2.2. Methods

An atomic force microscope (AFM) (Digital Instruments, Mod. Nanoscope E, USA) and its own software was used in contact mode to image the

samples. These measurements were performed in air (ex-situ) using silicon nitride AFM tips (Digital Instruments), in the same room, at room temperature (297 ± 1 K), ambient pressure and (50 ± 1 %) relative humidity. The measurements were repeated for three times for each sample on different reference areas. The resolution of the AFM images was 256 pixels by 256 pixels. The Digital Surf MountainsMap® Premium software version 7 [15] was used for surface characterization of the AFM images, for estimation of areal surface texture parameters in accordance with ISO 25178-2:2012 [16].

2.3. Multifractal analysis of the 3-D surface texture

Multifractal analysis is a useful method, based on the multifractal theory that can be applied to characterize the spatial inhomogeneity of both theoretical and experimental fractal patterns [17–21]. Multifractal analysis has clearly an advantage compared with standard statistical approaches because its parameters are independent over a range of scales as well as that no assumption is required about the data following any specific distribution. Also, it gives information about both local and global properties of the analyzed datasets [22].

The fundamental characteristics of multifractal distributions are: a) the generalized fractal dimensions function D_q , where q is a real parameter within the domain $[-\infty, +\infty]$ that indicates the order of the moment of the measure; and b) the singularity spectrum $f(\alpha)$, where α is named Hölder or singularity exponent that quantifies the strength of the measure singularities [20]. The multifractal spectrum can be calculated explicitly through several methods [22–26].

The generalized dimensions, D_q for $q = 0$, $q = 1$ and $q = 2$, are referred as the capacity (or box-counting), the information entropy and correlation dimensions, respectively. The function D_q is a linear function of q for monofractal sets, while for multifractal sets D_q is a non-linear function of q . Any asymmetry of the function of D_q is an indicator of an asymmetrical probability distribution [27]. The computed dimensions, D_0 , D_1 and D_2 for

multifractal sets, are different, satisfying the relation: $D_0 > D_1 > D_2$.

On the other hand, the $D(q)$ spectrum and the singularity spectrum $f(\alpha)$ are connected via a Legendre transform as [23]:

$$f(\alpha(q)) = q\alpha(q) - \tau(q) \quad (1)$$

where $\alpha(q)$ represents Hölder exponents of the q -th order moment and $\tau(q)$ is the mass correlation exponent of the q -th order. The entire spectrum of generalized fractal dimensions is also included in the plot $f(\alpha)$. The singularity spectrum $f(\alpha(q))$ takes its maximum value for $q = 0$ and usually has a parabolic shape around this point. The spectrum width or degree of multifractality is defined as $\Delta\alpha = \alpha_{\max} - \alpha_{\min}$ and a broader spectrum of $\Delta\alpha$ is associated with a higher degree of multifractality. Another quantitative measurement is the spectrum arms' height difference defined as: $\Delta f = f(\alpha_{\min}) - f(\alpha_{\max})$. If $\Delta f < 0$, the fragments described by the low probability value predominate; whereas for $\Delta f > 0$ the fragments described by the high probability value predominate [28].

In our study, the multifractal analysis of the AFM files was performed for each region of interest (ROI), using the box counting method. The analysis was based on the original algorithm that has been previously described in detail in the literature [29, 30].

The 3-D surface topography of thin films is proven to possess only a statistical self-similarity, which takes place only in the restricted range of the spatial scales when maintaining the characteristics of continuity, non-differentiability and self-similarity of the structure [18, 31–33].

Different investigators highlighted a correlation between the different surface roughness parameters and the multifractal spectrum $f(\alpha)$ [18–21].

2.4. Statistical analysis

Statistical analyses were performed using the GraphPad InStat version 3.2.0 computer software package (GraphPad, San Diego, CA, USA) [34]. Comparisons among different areas within the same sample were performed using independent samples T-test. When statistical significance was

found, the difference between two groups was further compared using the Mann-Whitney U test. Differences with a P value of 0.05 or less were considered statistically significant. The average D_q results were expressed as mean value and standard deviation.

3. Results

One set of representative 3D topographic AFM images of layers grown at different temperatures, in perspective view, for scanning square area of $1 \mu\text{m} \times 1 \mu\text{m}$, are shown in Fig. 1: (a) 473 K, (b) 573 K, (c) 673 K, and (d) 773 K.

The depth histograms associated with Fig. 1 that enable us to observe the density of the distribution of the data points on the surface, are shown in Fig. 2. The vertical axis is graduated in depths, while the horizontal axis is graduated in % of the whole population. The Abbott-Firestone curve is overlaid in red. This function is the cumulating function of the amplitude distribution function. The horizontal axis represents the bearing ratio (in %), and the vertical axis represents the depths (in the measurement unit).

To illustrate how the multifractality can be quantified, the multifractal singularity spectra $f(\alpha)$ calculated for all microstructures of Fig. 1 in the range $-10 \leq q \leq 10$ for successive 1.0 steps, are shown altogether in Fig. 3.

The values resulting from the multifractal analysis (based on the box-counting method) and the corresponding values of generalized fractal dimensions D_q are listed in Table 1.

Table 2 contains the areal surface texture parameters of the AFM images, according with ISO 25178-2:2012 [16].

4. Discussion

The 3-D surface topographies of (TiN) thin films prepared by reactive DC magnetron sputtering are geometrically complex, with complicated patterns and shapes, and can be described, both locally and globally, by means of the multifractal analysis.

Table 1. The generalized dimensions D_q for $q = 0, 1, 2$, all with average \pm standard deviation, for the AFM images of TiN layers nanostructures grown at: (a) 473 K, (b) 573 K, (c) 673 K, and (d) 773 K. $\Delta\alpha$ is the multifractal width spectrum ($\Delta\alpha = \alpha_{\max} - \alpha_{\min}$). Δf is the spectrum arms' heights difference $\Delta f = f(\alpha_{\min}) - f(\alpha_{\max})$. Scanning square areas of $1 \times 1 \mu\text{m}^2$. Statistically significant difference for all values: $P < 0.05$.

The multifractal parameters	Samples of grown TiN layers nanostructures			
	473 K	573 K	673 K	773 K
D_0	2.0000 ± 0.0001	2.0000 ± 0.0001	2.0000 ± 0.0001	2.0000 ± 0.0001
D_1	1.9976 ± 0.0001	1.9227 ± 0.0001	1.9110 ± 0.0007	1.9033 ± 0.0002
D_2	1.9879 ± 0.0004	1.6387 ± 0.0004	1.6261 ± 0.0003	1.6068 ± 0.0004
α_0	2.0020 ± 0.0008	2.0669 ± 0.0127	2.0773 ± 0.0046	2.0888 ± 0.0052
α_1	1.9976 ± 0.0010	1.9227 ± 0.0154	1.9110 ± 0.0057	1.9033 ± 0.0060
α_2	1.9912 ± 0.0041	1.7340 ± 0.0493	1.7195 ± 0.0170	1.7045 ± 0.0136
α_{\max}	2.0162 ± 0.0041	2.2810 ± 0.0056	2.2962 ± 0.0062	2.3603 ± 0.0122
α_{\min}	1.8139 ± 0.0396	1.4068 ± 0.0260	1.3849 ± 0.0113	1.3527 ± 0.0126
$\Delta\alpha = \alpha_{\max} - \alpha_{\min}$	0.2023	0.8742	0.9113	1.0076
f_0	2.0000 ± 0.0001	2.0000 ± 0.0001	2.0000 ± 0.0001	2.0000 ± 0.0001
f_1	1.9976 ± 0.0010	1.9227 ± 0.0154	1.9110 ± 0.0057	1.9032 ± 0.0060
f_2	1.9878 ± 0.0058	1.6386 ± 0.0653	1.6261 ± 0.0223	1.6068 ± 0.0165
$f(\alpha_{\min})$	0.8479 ± 0.1456	0.4380 ± 0.0720	0.3133 ± 0.1860	0.3436 ± 0.0465
$f(\alpha_{\max})$	1.9517 ± 0.0065	1.5530 ± 0.0831	1.5626 ± 0.0621	1.4880 ± 0.0793
$\Delta f = f(\alpha_{\min}) - f(\alpha_{\max})$	-1.1038	-1.1150	-1.2493	-1.1444

In all AFM images, it can be seen that due to the grow process, the 3-D surface of the samples are covered by nanoasperities with different distributions of asperity height and density, and with different shapes of asperity apex (Fig. 1). This surface pattern is a first confirmation of the surface geometrical multifractal nature.

In the multifractal analysis based on box-counting method, the computed spectrum of fractal dimensions reveals the heterogeneity in the distribution. In all results, the relation $D_0 > D_1 > D_2$ is verified, which indicates that the (TiN) thin films have the 3-D surface roughness with multifractal scaling property.

All the $f(\alpha)$ graphs are asymmetric with respect to the variable α . Multifractal spectra $f(\alpha)$ show that the higher the substrate temperature, the wider is the multifractal width spectrum ($\Delta\alpha = \alpha_{\max} - \alpha_{\min}$) with $\Delta\alpha > 0$. In the formalism of multifractals, α_{\min} is related to the maximum probability measure, while α_{\max} is related to the minimum probability measure. Thus, the multifractal width spectrum $\Delta\alpha$ can be used to describe the range of the probabilities.

For all the samples the left shoulder of the multifractal singularity spectrum $f(\alpha)$ is much longer than the right shoulder. When the multifractal spectrum is wider than another it indicates that we need more fractal dimensions in order to describe the multifractal structure. It can be seen that the shapes of the multifractal spectra $f(\alpha)$ versus α are different and are all mainly hook-like to the left. The left shoulder of the multifractal singularity spectrum $f(\alpha)$ for the surface obtained at 773 K is much longer than those of the samples obtained at 673 K, 573 K and 473 K, respectively. The left arm of the multifractal spectrum corresponds to strongly irregular areas, defined by a high dimension value, whereas the right arm of the multifractal spectrum is associated with flat areas, being characteristic of large convex and concave surfaces [28].

The most regular surface is obtained for 473 K with a minimum value of $\Delta\alpha = 0.2023$.

$\Delta f = f(\alpha_{\min}) - f(\alpha_{\max})$ corresponds to the ratio of the number of the maximum probability and that of the minimum one. For all the samples the spectrum arms' height difference $\Delta f < 0$, and it falls within the range of -1.25 to -1.10 ,

Table 2. The areal surface texture parameters of the TiN layers nanostructures grown at: (a) 473 K, (b) 573 K, (c) 673 K, and (d) 773 K, for scanning square areas of $1 \times 1 \mu\text{m}^2$, according with ISO 25178-2:2012. Statistically significant difference for all values: $P < 0.05$.

The statistical parameters	Symbol	Samples at temperature			
		473 K	573 K	673 K	773 K
Height parameters					
Root mean square height	Sq [nm]	0.616	2.71	4.51	4.82
Skewness	Ssk [-]	0.213	-0.142	-0.006	-0.249
Kurtosis	Sku [-]	3.15	4.02	3.06	2.83
Maximum peak height	Sp [nm]	2.90	13.1	17.7	14.6
Maximum pit height	Sv [nm]	2.10	16.9	18.3	17.9
Maximum height	Sz [nm]	5.01	30.1	36.0	32.5
Arithmetic mean height	Sa [nm]	0.491	2.09	3.58	3.89
Functional parameters					
Areal material ratio	Smr [%]	100	100	100	100
Inverse areal material ratio	Smc [nm]	0.802	3.30	5.87	6.18
Extreme peak height	Sxp [nm]	1.13	5.54	8.79	10.0
Spatial parameters					
Auto-correlation length	Sal [μm]	0.0262	0.0153	0.0324	0.0287
Texture-aspect ratio	Str [-]	0.637	0.417	0.675	0.773
Texture direction	Std [$^\circ$]	177 $^\circ$	5.75 $^\circ$	12.3 $^\circ$	12.8 $^\circ$
Hybrid parameters					
Root mean square gradient	Sdq [-]	0.0634	0.414	0.394	0.468
Developed interfacial area ratio	Sdr [%]	0.200	7.32	6.80	9.46
Functional parameters (Volume)					
Material volume	Vm [$\mu\text{m}^3/\mu\text{m}^2$]	3.18e-005	0.00013	0.00020	0.00017
Void volume	Vv [$\mu\text{m}^3/\mu\text{m}^2$]	0.000834	0.00344	0.00607	0.00635
Peak material volume	Vmp [$\mu\text{m}^3/\mu\text{m}^2$]	3.18e-005	0.00013	0.00020	0.00017
Core material volume	Vmc [$\mu\text{m}^3/\mu\text{m}^2$]	0.000548	0.00233	0.00406	0.00448
Core void volume	Vvc [$\mu\text{m}^3/\mu\text{m}^2$]	0.000769	0.00310	0.00556	0.00576
Pit void volume	Vvv [$\mu\text{m}^3/\mu\text{m}^2$]	6.47e-005	0.00033	0.00051	0.00058
Feature parameters					
Density of peaks	Spd [$1/\mu\text{m}^2$]	133	231	91.7	143
Arithmetic mean peak curvature	Spc [$1/\mu\text{m}$]	20.7	131	65.9	67.0
Ten point height	S10z [nm]	3.25	20.0	22.3	23.7
Five point peak height	S5p [nm]	1.88	9.12	10.7	11.0
Five point pit height	S5v [nm]	1.37	10.9	11.7	12.8
Mean daled area	Sda [μm^2]	0.00579	0.00383	0.00755	0.00555
Mean hill area	Sha [μm^2]	0.00619	0.00404	0.0106	0.00713
Mean daled volume	Sdv [μm^3]	3.3e-007	1.4e-006	3.2e-006	2.0e-006
Mean hill volume	Shv [μm^3]	5.18e-007	1.7e-006	9.7e-006	5.2e-006

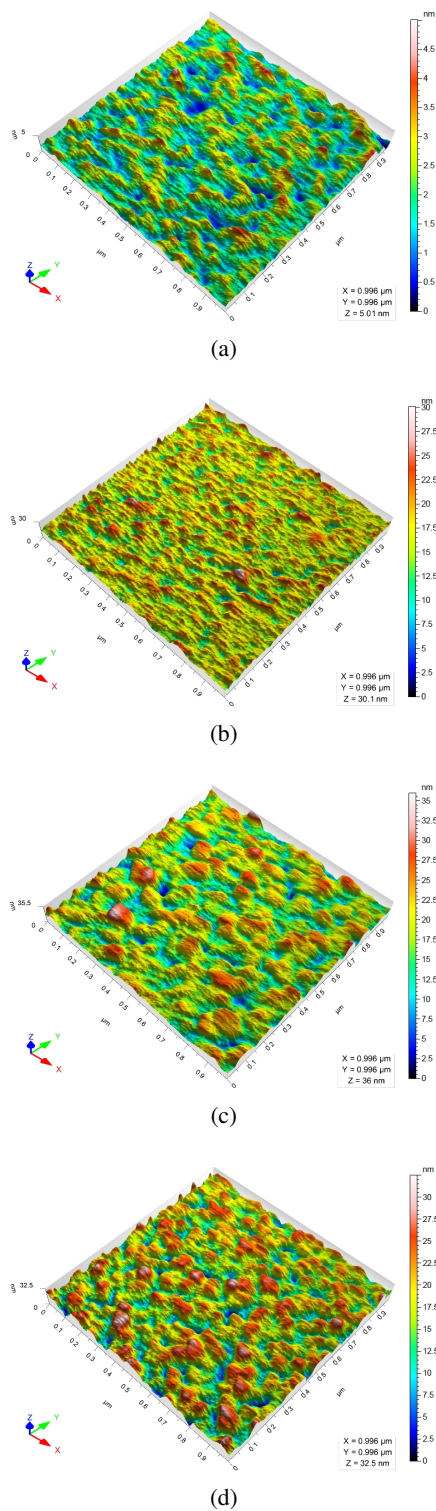


Fig. 1. One set of representative 3-D topographic AFM images of TiN grown layers, obtained at: (a) 473 K, (b) 573 K, (c) 673 K, and (d) 773 K in perspective view, for scanning square area of $1 \mu\text{m} \times 1 \mu\text{m}$.

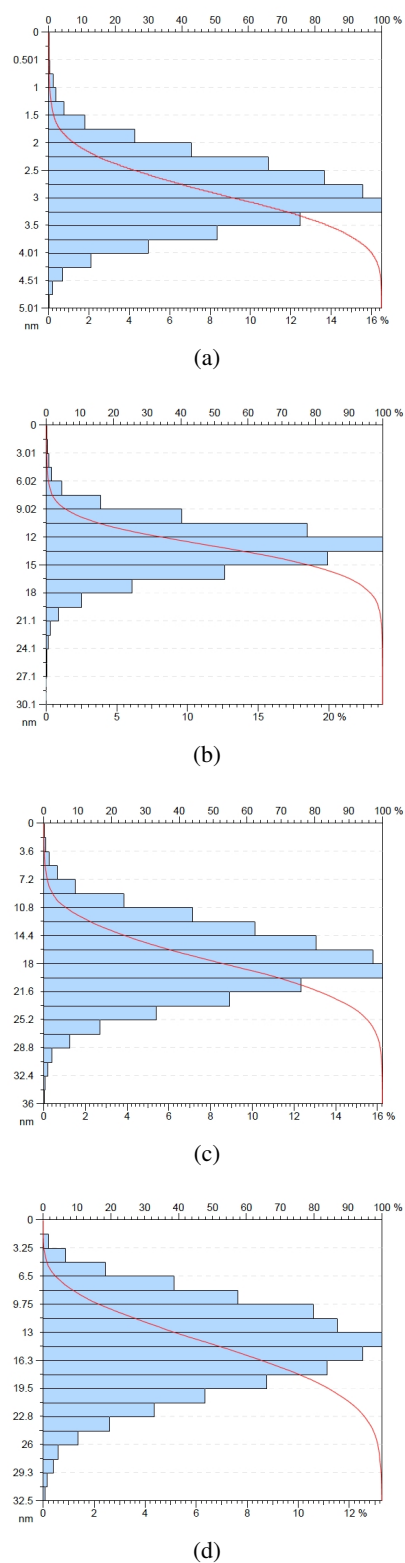


Fig. 2. The depth histograms of TiN grown layers, obtained at: (a) 473 K, (b) 573 K, (c) 673 K, and (d) 773 K for scanning square area of $1 \mu\text{m} \times 1 \mu\text{m}$.

depending upon the samples temperature; that imply the fragments, where the low probability values predominate. The value of Δf decreases with the substrate temperature variation from -1.1038 (at 473 K) to -1.1150 (at 573 K). From the lowest value of -1.2493 (at 673 K) it increases to -1.1444 at 773 K (Fig. 3).

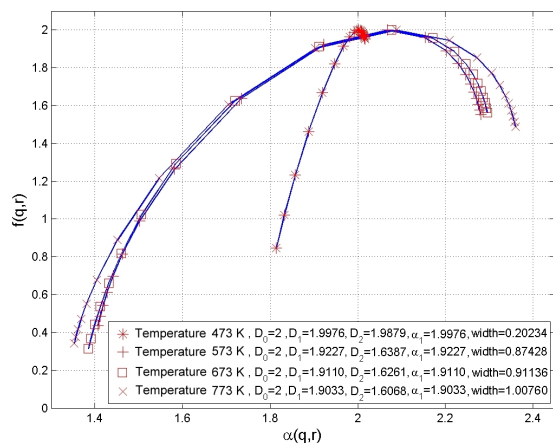


Fig. 3. Multifractal singularity spectrum $f(\alpha)$ of TiN layers grown at (a) 473 K, (b) 573 K, (c) 673 K, and (d) 773 K, with the generalized dimensions D_q for $q = 0, 1, 2$, for scanning square area of $1 \mu\text{m} \times 1 \mu\text{m}$.

The smoothest surface, corresponding to the lowest values of height parameters (S_q , S_p , S_v , S_z and S_a), functional parameters, hybrid parameters, and functional parameters (volume), was found in the TiN layers grown at 473 K. The others TiN layers grown at 573 K, 673 K and 773 K, have different values of the statistical parameters, all higher than the corresponding values obtained at 473 K. Our results suggest that the surface morphology of (TiN) thin films, prepared by reactive DC magnetron sputtering, gets textured with an increase in temperature of the substrate, and can be tailored to particular morphologies. According to Bavadi et al. [35], TiN thin films have the grains preferentially oriented along (101), (200) between 43 and 44 degree. On the other hand, the obtained values are in good agreement with the experimental and theoretical results reported in the literature [35, 36], confirming the overall quality of the data reduction procedure.

5. Conclusions

TiN thin films have been prepared at different temperatures of substrate by reactive DC magnetron sputtering. Their surface morphologies obtained from AFM images were subjected to statistical and multifractal analysis to quantitatively investigate their structural properties. The three important multifractal parameters D_q , $\Delta\alpha$ and Δf were calculated to describe the multifractal nature of the 3-D samples surfaces. AFM images show the nanostructure of the thin films with varying surface topography and increasing surface roughness upon increasing the substrate temperature. The morphology of the analyzed samples provides a more complete description of the structural features that can contribute to subsequent integration into the nanotribology processes, from both theoretical and experimental perspectives. Statistical parameters and multifractal analysis are valuable approaches to study the AFM images of surface topography of (TiN) thin films prepared by reactive DC magnetron sputtering. The multifractal behavior also can be used to develop 3-D mathematical models, which helps to study the 3-D grow processes on TiN layers.

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